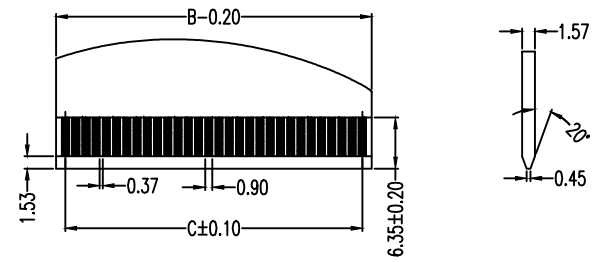


Recommended PCB Layout(Top View)



Daughter Card Layout

SPECIFICATION
 Current Rating:1 Amp
 Voltage Rating:250V AC RMS
 Dielectric Withstanding Voltage:500V AC RMS 60Hz For 1 Minute
 Insulation Resistance:1000 Megaohms Min. At 500V DC
 Contact Resistance:30 Milliohms Max.
 Retention Force:460 Grams Min. Per Contact
 Insertion Force:250 Grams Max. Per Contact Pair
 Withdrawal Force:15 Grams Min. Per Contact Pair
 Temperature Range:-55°C~105°C
 Insulator:LCP+G. F.
 Contact:Phosphor Bronze
 Gold Plated On Contact Area
 Tin Plated On Solder Tails, Over Nickel
 Or All Gold Plated On Contact

RoHS Compliant

Order Information

HE D xxx LP 03 BK

HE=1.27mm FEMALE EDGE SLOT
 D=DIP STRAIGHT 180°
 NO. OF PINS:04-200
 Operating Temperature
 LP=LCP + Phosphor Bronze

BK=Black
 NC=Natural Color
 GF=1u" Glod Flash
 03=3u" Glod
 05=5u" Glod
 10=10 u" Glod
 15=15 u" Glod
 A3=3u" ALL Glod

Pin	4 to 300
Dimension	
A	1.27xNo. of Pin/2+6.1
B	1.27xNo. of Pin/2+1.27
C	1.27xNo. of Pin/2-1.27



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X. ± 0.30	APPD:	PART NO: HE D xxx LP 03 BK		
.X ± 0.20	CHKD:			
.XX ± 0.10	DR:			
.XXX± 0.05				
X° ± 1°				
X° ± 0.5°				
UNITS: mm		SCALE: 1:1	DWG NO:	SHEET 4 OF 1
				REV: A

REV	ECN NO	DESCRIPTION	DATE
A			